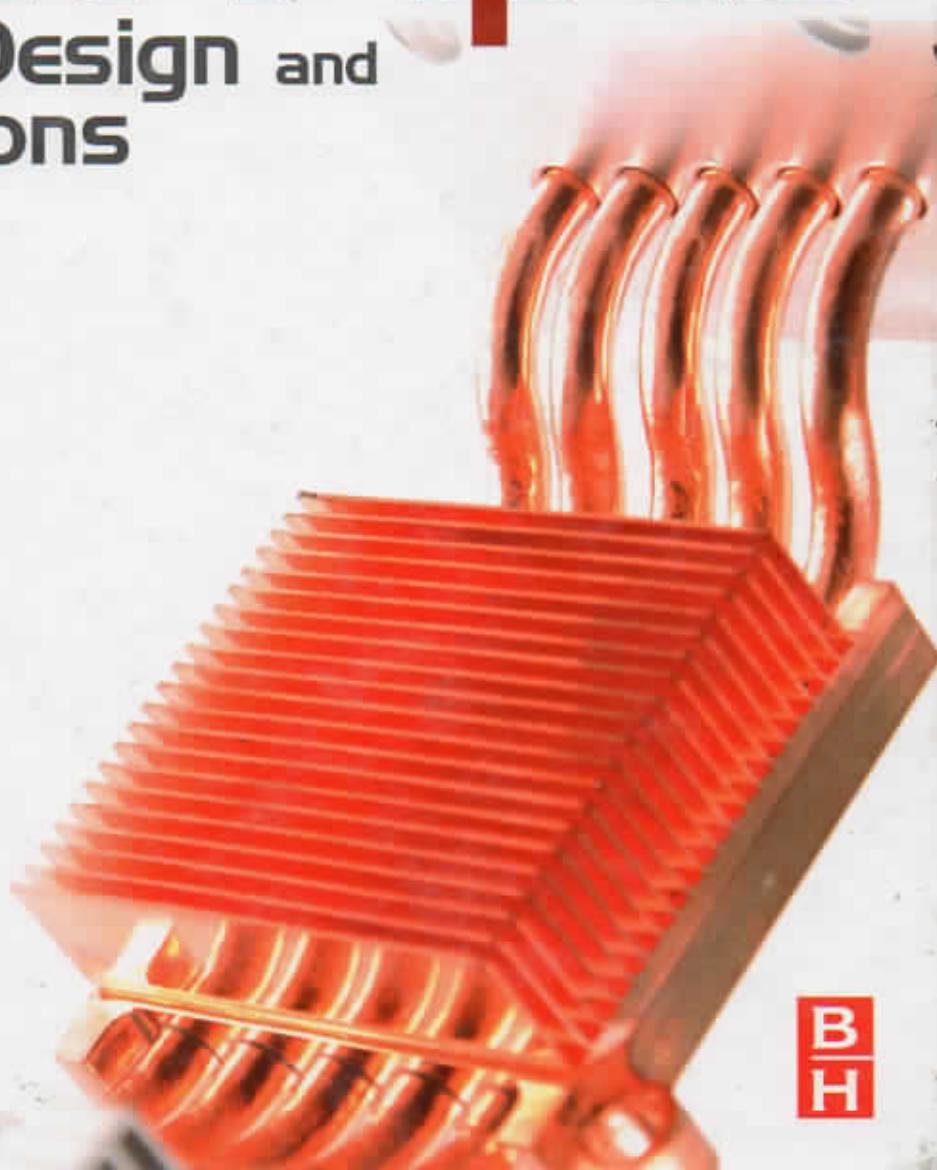


David Reay | Peter Kew | Ryan McGlen

Sixth Edition

Heat Pipes

Theory, Design and Applications



B
H

Heat Pipes

Theory, Design and Applications

Sixth Edition

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